AO6422

N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO6422/L uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for general purpose application.

AO6422 and AO6422L are electrically identical.

-RoHS Compliant

-AO6422L is Halogen Free

Features

$$V_{DS} = 20V$$

 $I_D = 5A$ $(V_{GS} = 4.5V)$

 $R_{DS(ON)} < 44m\Omega$ ($V_{GS} = 4.5V$)

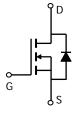
 $R_{DS(ON)} < 55m\Omega$ ($V_{GS} = 2.5V$)

 $R_{DS(ON)} < 72m\Omega$ ($V_{GS} = 1.8V$)









Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	10 Sec	Steady State	Units		
Drain-Source Voltage		V_{DS}	20		V		
Gate-Source Voltage		V_{GS}	±8		V		
Continuous Drain	T _A =25°C		5	3.9			
Current ^A	T _A =70°C	I _D	4.2	3	Α		
Pulsed Drain Current ^B		I _{DM}	30				
Power Dissipation ^A	T _A =25°C	В	2.0	1.1	W		
	T _A =70°C	$-P_{D}$	1.3	0.7	VV		
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150		°C		

Thermal Characteristics							
Parameter	Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient ^A	t ≤ 10s Steady State		47.5	62.5	°C/W		
Maximum Junction-to-Ambient A			74	110	°C/W		
Maximum Junction-to-Lead ^C	Steady State	$R_{\scriptscriptstyle{ hetaJL}}$	54	68	°C/W		

1/4 www.freescale.net.cn



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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20V, V _{GS} = 0V			1	μА
		$T_J = 55^{\circ}C$			5	μΛ
I_{GSS}	Gate-Body leakage current	$V_{DS} = 0V$, $V_{GS} = \pm 8V$			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_{D} = 250 \mu A$	0.4	0.65	1	V
$I_{D(ON)}$	On state drain current	$V_{GS} = 4.5V, V_{DS} = 5V$	30			Α
R _{DS(ON)} Static Drain-Source On-Resista		$V_{GS} = 4.5V, I_D = 5.0A$		35	44	mΩ
	Static Drain Source On Posistance	T _J =125°C		48	60	11122
	Static Dialii-Source Oil-Resistance	$V_{GS} = 2.5V, I_D = 4.5A$		43	55	mΩ
		$V_{GS} = 1.8V, I_D = 3.5A$		55	72	mΩ
g FS	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		14		S
V_{SD}	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.8	1	V
I _S	Maximum Body-Diode Continuous Current				2	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			450	560	pF
Coss	Output Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		74		pF
C _{rss}	Reverse Transfer Capacitance			52		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		4.9	7.5	Ω
SWITCHI	NG PARAMETERS					
Q _g (4.5V)	Total Gate Charge			6.2	8.2	nC
Q_{gs}	Gate Source Charge	V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 5A		0.4		nC
Q_{gd}	Gate Drain Charge			1.3		nC
t _{D(on)}	Turn-On DelayTime			4.5		ns
t _r	Turn-On Rise Time	V_{GS} =4.5V, V_{DS} =10V, R_L =2 Ω ,		6		ns
$t_{D(off)}$	Turn-Off DelayTime	R_{GEN} =3 Ω		33		ns
t _f	Turn-Off Fall Time]		7.1		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dI/dt=100A/μs		13	17	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs		3.3		nC

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ = 25°C. in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t \leq 300 μ s pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T _A=25°C. The SOA curve provides a single pulse rating.



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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

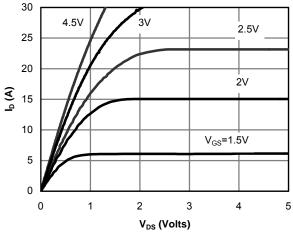


Figure 1: On-Region Characteristics

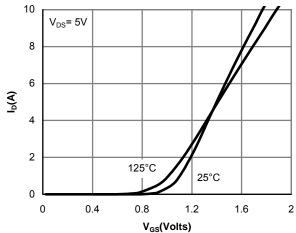


Figure 2: Transfer Characteristics

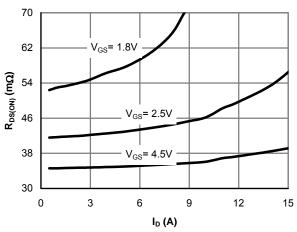


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

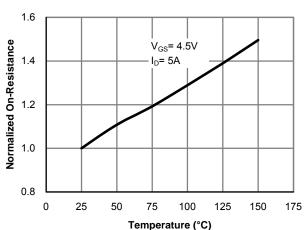


Figure 4: On-Resistance vs. Junction Temperature

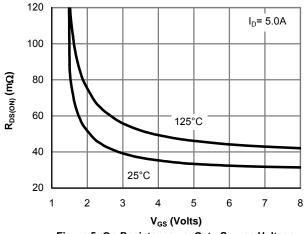


Figure 5: On-Resistance vs. Gate-Source Voltage

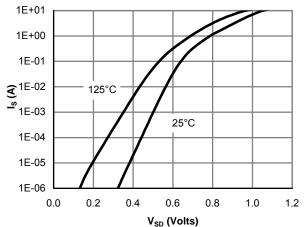


Figure 6: Body-Diode Characteristics



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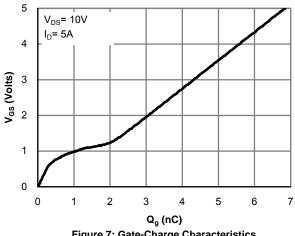


Figure 7: Gate-Charge Characteristics

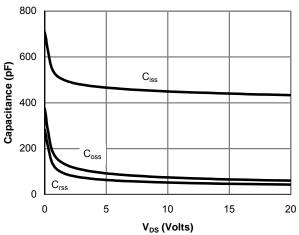


Figure 8: Capacitance Characteristics

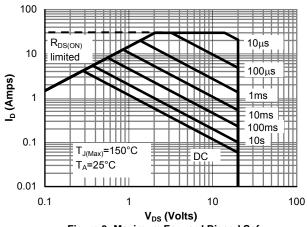


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

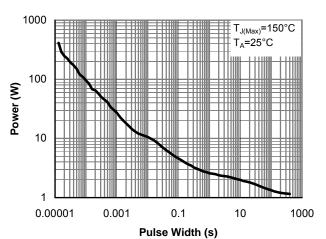


Figure 10: Single Pulse Power Rating Junctionto-Ambient (Note E)

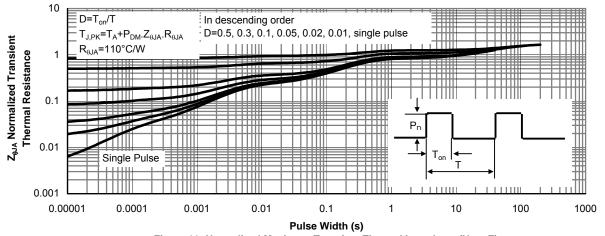


Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

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